## PRODUCT NUMBER STRUCTURE

10164227 - AAABCDELF

## No.of Pins:

$020=20 \mathrm{Pin} ; 024=24 \mathrm{Pin} ;$
$030=30 \mathrm{Pin} ; 034=34 \mathrm{Pin} ;$
$040=40 \mathrm{Pin} ; 050=50 \mathrm{Pin} ;$
$060=60 \mathrm{Pin} ; 070=70 \mathrm{Pin} ;$
$080=80 \mathrm{Pin} ; 090=90 \mathrm{Pin} ;$
Height:
$=1.45 \mathrm{~mm}$
Contact plating: $\longrightarrow$
$A=$ Gold flash
Gd dom:
Hold down:
= Without hold down
Packing:
$\mathrm{R}=$ Tape \& Reel
LF:
$L F=$ Lead free

1.CURRENT RATING: 0.3A;
2. VOLTAGET RATING: 30V AC ;
3. CONTACT RESISTANCE: $90 \mathrm{~m} \Omega$ Max;
4.WTHSTAND VOLTAGE: 100V AC;
5.INSULATION RESISTANCE: $50 \mathrm{M} \Omega \mathrm{Min}$
6.INSULATOR MATERIAL: LCP,G.F,UL94V-0,BK
7.CONTACT MATERIAL: Copper Alloy;
8.CONTACT PLATING:

GOLD FLASH ON CONTACT AREA(SEE ORDERING INFOMATION),
$50 \mu "$ NICKEL UNDERPLATING OVERALL;
9.CO-PLANARITY FOR CONTACT TAILS MUST BE 0.1 mm MAX.
10. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND

OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004
10.THE HOUSING WILL WITHSTAND EXPOSURE TO $260^{\circ} \mathrm{C}$ PEAK

TEMPERATURE FOR 10SECONDS IN A REFLOW SOLDERING OVEN.
12.RECOMMENDED STENCIL THICKNESS IS 120um.
13.RECOMMENDED STENCIL OPENING RATIO IS $80 \%$.
14.PRODUCT SPEC: GS-12-1404.
15. THE DOCUMENT MAY BE CHANGED WITHOUT PRIOR NOTICE.
$\qquad$


## PRODUCT NUMBER STRUCTURE

10164227 - AAABCDELF

No.of Pins:
$2=20 \mathrm{Pin} ; 030=30 \mathrm{Pin}$
$40=40 \mathrm{Pin} ; 050=50 \mathrm{Pin} ;$
$060=60 \mathrm{Pin} ; 070=70 \mathrm{Pin}$
Height:
$2=2.4 \mathrm{~mm}$
Contact plating:
$\mathrm{A}=$ Gold flash



Note
1.CURRENT RATING: 0.3A;
2.VOLTAGET RATING: 30 V AC;
3.CONTACT RESISTANCE: $90 \mathrm{~m} \Omega$ Max;
4.WTHSTAND VOLTAGE : 100 V AC;
5.INSULATION RESISTANCE: 50M @ Min;
6.INSULATOR MATERIAL: LCP,G.F,UL94V-0,BK;
7.CONTACT MATERIAL: Copper Alloy;
8. CONTACT PLATING:

GOLD FLASH ON CONTACT AREA(SEE ORDERING INFOMATION),
$50 \mu "$ NICKEL UNDERPLATING OVERALL;
9.CO-PLANARITY FOR CONTACT TAILS MUST BE 0.1 mm MAX.
10. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND

OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004.
10. THE HOUSING WILL WITHSTAND EXPOSURE TO $260^{\circ} \mathrm{C}$ PEAK

TEMPERATURE FOR 10SECONDS IN A REFLOW SOLDERING OVEN.
12.RECOMMENDED STENCIL THICKNESS IS 120 um .
13.RECOMMENDED STENCIL OPENING RATIO IS $80 \%$.
14.PRODUCT SPEC: GS-12-1404.
15. THE DOCUMENT MAY BE CHANGED WITHOUT PRIOR NOTICE.


PRODUCT NUMBER STRUCTURE

No.of Pins:
0.0 Pins. $\quad 040=40 \mathrm{Pin}$.
$044=44 \mathrm{Pin} ; 050=50 \mathrm{Pin}$;
$060=60$ Pin; $070=70 \mathrm{Pin} ;$
$080=80$ Pin; $090=90$ Pin;
$100=100 \mathrm{Pin}$;
Height:
Contact plating:



Hold down:
1=Without hold down
Pocking:
Tape \& Reel
$\mathrm{LF}: \overline{L F=\text { eod free }}$


Note
1.CURRENT RATING: 0.3A ;
2.VOLTAGET RATING: 3OV AC ;
3.CONTACT RESISTANCE: $90 \mathrm{~m} \Omega$ Max;
4.WITHSTAND VOLTAGE : 100V AC;
5.INSULATION RESISTANCE: 50M $\Omega$ Min;
6.INSULATOR MATERIAL: LCP,G.F,UL94V-0,BK
7.CONTACT MATERIAL: Copper Alloy;
8.CONTACT PLATING:

GOLD FLASH ON CONTACT AREA(SEE ORDERING INFOMATION),
$50 \mu "$ NICKEL UNDERPLATING OVERALL
9.CO-PLANARITY FOR CONTACT TAILS MUST BE 0.1 mm MAX.
10. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND

OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004.
10.THE HOUSING WILL WITHSTAND EXPOSURE TO $260^{\circ} \mathrm{C}$ PEAK

TEMPERATURE FOR 1OSECONDS IN A REFLOW SOLDERING OVEN.
12.RECOMMENDED STENCIL THICKNESS IS 120um.
13.RECOMMENDED STENCIL OPENING RATIO IS $80 \%$.
14.PRODUCT SPEC: GS-12-1404.
15. THE DOCUMENT MAY BE CHANGED WITHOUT PRIOR NOTICE.


| PART NO. | NO.of <br> contacts | A | B | C |
| :---: | :---: | :---: | :---: | :---: |
| 10164227-0303A1RLF | 30 | 8.60 | 5.60 | 1.5 |
| 10164227-0403A1RLF | 40 | 10.60 | 7.60 | 3.2 |
| 10164227-0443A1RLF | 44 | 11.40 | 8.40 | 3.2 |
| 10164227-0503A1RLF | 50 | 12.60 | 9.60 | 3.2 |
| 10164227-0603A1RLF | 60 | 14.60 | 11.60 | 3.2 |
| 10164227-0703A1RLF | 70 | 16.60 | 13.60 | 3.2 |
| 10164227-0803A1RLF | 80 | 18.60 | 15.60 | 3.2 |
| 10164227-0903A1RLF | 90 | 20.60 | 17.60 | 3.2 |
| 10164227-1003A1RLF | 100 | 22.60 | 19.60 | 3.2 |

$\qquad$


## PRODUCT NUMBER STRUCTURE

10164227 - AAABCDELF
$50=50 \mathrm{Pin} ; 060=60 \mathrm{Pin}$ $080=80$ Pin; 090=90Pin

Height:
$4=3.9 \mathrm{~mm}$
ontact plating:
Hold down:
=Without hold down
Pocking:
R=Tope \& R
$R=$ Tape \& Reel
$L F=$ Lead free

## Note

1.CURRENT RATING: 0.3A ;
2.VOLTAGET RATING: 30V AC ; 3. CONTACT RESISTANCE: $90 \mathrm{~m} \Omega$ Max;

4.WWTHSTAND VOLTAGE : 100 V AC;
5.INSULATION RESISTANCE: $50 \mathrm{M} \Omega \mathrm{Min}$ :
6.INSULATOR MATERIAL: LCP,G.F,UL94V-0,BK;
7.CONTACT MATERIAL: Copper Alloy
8.CONTACT PLATING:

GOLD FLASH ON CONTACT AREA(SEE ORDERING INFOMATION),
$50 \mu "$ NICKEL UNDERPLATING OVERALL;
9.CO-PLANARITY FOR CONTACT TAILS MUST BE 0.1 mm MAX
10.THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND

OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004.
10.THE HOUSING WILL WITHSTAND EXPOSURE TO $260^{\circ} \mathrm{C}$ PEAK

TEMPERATURE FOR 10SECONDS IN A REFLOW SOLDERING OVEN.
12.RECOMMENDED STENCIL THICKNESS IS 120um.
13.RECOMMENDED STENCIL OPENING RATIO IS $80 \%$.
14.PRODUCT SPEC : GS-12-1404.
15. THE DOCUMENT MAY BE CHANGED WITHOUT PRIOR NOTICE.



| PART NO. | NO.of <br> contacts | A | B | C |
| :---: | :---: | :---: | :---: | :---: |
| 10164227-0404A1RLF | 40 | 10.60 | 7.60 | 3.2 |
| 10164227-0504A1RLF | 50 | 12.60 | 9.60 | 3.2 |
| 10164227-0604A1RLF | 60 | 14.60 | 11.60 | 3.2 |
| 10164227-0704A1RLF | 70 | 16.60 | 13.60 | 3.2 |
| 10164227-0804A1RLF | 80 | 18.60 | 15.60 | 3.2 |
| 10164227-0904A1RLF | 90 | 20.60 | 17.60 | 3.2 |
| 10164227-1004A1RLF | 100 | 22.60 | 19.60 | 3.2 |



PRODUCT NUMBER STRUCTURE
10164227 - AAABCDELF

No.of Pins:
$020=20 \mathrm{Pin} ; 030=30 \mathrm{Pin} ;$
$040=40 \mathrm{Pin} ; 050=50 \mathrm{Pin} ;$

Height:
$5=3.45 \mathrm{~mm}$
Contact plating:

$A=$ Gold flash
Hold down:
=Without hold down
Pocking:
=Tope \& Reel
$\mathrm{LF}:$
$\mathrm{LF}=$ Lead free

Note
1.CURRENT RATING: 0.3A ;
2.VOLTAGET RATING: 30 V AC ;
3. CONTACT RESISTANCE: $90 \mathrm{~m} \Omega$ Max;
4.WTHSTAND VOLTAGE : 100V AC;

5.INSULATION RESISTANCE: 50M Q Min;
6.INSULATOR MATERIAL: LCP,G.F,UL94V-0,BK;
7.CONTACT MATERIAL: Copper Alloy;
8. CONTACT PLATING:

GOLD FLASH ON CONTACT AREA(SEE ORDERING INFOMATION),
$50 \mu "$ N ICKEL UNDERPLATING OVERALL;
9.CO-PLANARITY FOR CONTACT TALLS MUST BE 0.1 mm MAX.
10.THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND

OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004.
10. THE HOUSING WIL WITHSTAND EXPOSURE TO $260^{\circ} \mathrm{C}$ PEAK

TEMPERATURE FOR 10SECONDS IN A REFLOW SOLDERING OVEN.
12.RECOMMENDED STENCIL THICKNESS IS 120um.
13.RECOMMENDED STENCLL OPENING RATIO IS $80 \%$.
14.PRODUCT SPEC: GS-12-1404.
15. THE DOCUMENT MAY BE CHANGED WITHOUT PRIOR NOTICE.

| PART NO. | NO.of <br> contacts | A | B | C |
| :---: | :---: | :---: | :---: | :---: |
| 10164227-0205A1RLF | 20 | 6.60 | 3.60 | 1.0 |
| 10164227-0305A1RLF | 30 | 8.60 | 5.60 | 1.5 |
| 10164222-0405A1RLF | 40 | 10.60 | 7.60 | 3.2 |
| 10164227-0505A1RLF | 50 | 12.60 | 9.60 | 3.2 |
| 10164227-0605A1RLF | 60 | 14.60 | 11.60 | 3.2 |
| 10164227-0805A1RLF | 80 | 18.60 | 15.60 | 3.2 |





## PRODUCT NUMBER STRUCTURE

10164227 - AAABCDELF
No.of Pins:
$\square$
$020=20 \mathrm{Pin} ; 024=24 \mathrm{Pin} ;$
$030=30 \mathrm{Pin} ; 040=40 \mathrm{Pin}$,
070=700in;080=80ㄹin;

Height:
$6=1.95 \mathrm{~mm}$
Contact plating:
Contact plating
$B=8 u^{\prime \prime} \mathrm{Min}$ AL
$B=8 u^{\prime \prime}$ Min. AU
old down:
1=Without hold down
Pocking:
LF:
$\mathrm{LF}=$ Leod free

Note
1.CURRENT RATING: 0.3A ;
2.VOLTAGET RATING: 3OV AC ;
3.CONTACT RESISTANCE: $90 \mathrm{~m} \Omega$ Max;
4.WITHSTAND VOLTAGE : 100V AC;
5.INSULATION RESISTANCE: 50M $\Omega$ Min;
6.INSULATOR MATERIAL: LCP,G.F,UL94V-0,BK;
7.CONTACT MATERIAL: Copper Alloy;
8.CONTACT PLATING:

GOLD FLASH ON CONTACT AREA(SEE ORDERING INFOMATION),
$50 \mu "$ NICKEL UNDERPLATING OVERALL;
9.CO-PLANARITY FOR CONTACT TAILS MUST BE 0.1 mm MAX.
10. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND

OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004.
10.THE HOUSING WILL WITHSTAND EXPOSURE TO $260^{\circ} \mathrm{C}$ PEAK

TEMPERATURE FOR 10SECONDS IN A REFLOW SOLDERING OVEN.
12.RECOMMENDED STENCIL THICKNESS IS 120 um .
13.RECOMMENDED STENCIL OPENING RATIO IS 80\%.
14.PRODUCT SPEC: GS-12-1404.
15. THE DOCUMENT MAY BE CHANGED WITHOUT PRIOR NOTICE.




